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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application

Applicant(s): C.J. Miller et al.

Case:

2-1

Serial No.:

10/786,182

Filing Date:

February 25, 2004

Group:

2812

Examiner:

To Be Assigned

Title:

Methods and Apparatus for Integrated Circuit Ball Bonding

with Substantially Perpendicular Wire Bond Profiles

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Pursuant to 37 C.F.R. §§1.56, 1.97 and 1.98, Applicants' attorney wishes to bring to the attention of the Patent and Trademark Office the following document listed on the accompanying Form PTO-1449: V. Solberg, "Adapting Fine-Line Flex Circuits for 3D Multiple Die Packaging," Semiconductor Manufacturing, pp. 94-108, June 2003. A copy of the listed document is enclosed.

It is believed that there is no fee due in conjunction with the filing of this Information Disclosure Statement. In the event of non-payment or improper payment of a required fee, the Commissioner is authorized to charge or to credit Ryan, Mason & Lewis, LLP Deposit Account No. 50-0762 as required to correct the error.

The filing of this Information Disclosure Statement shall not be construed as a representation that a search has been made, or as an admission that the information cited is considered to be material to patentability, or as a representation that no other material information exists.

Respectfully submitted,

Joseph B. Ryan

Date: July 7, 2004

Reg. No. 37,922

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FORM PTO-1449 (MODIFIED)

LIST OF PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT



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			U.S. PATENT D	OCUMENTS		
EXAMINER						FILING DATE
INITIAL	DOCUMENT NO.	DATE	NAME		CLASS/SUBCLASS	IF APPROPRIATE
		FC	REIGN PATEN	T DOCUMENTS		
EXAMINER						TRANSLATION
INITIAL	DOCUMENT NO.	DATE	COUNTRY		CLASS/SUBCLASS	YES NO
			OTHER DO	CUMENTS		
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1. M	V. Solberg, "Alanufacturing, pp	Adapting Fin . 94-108, Jun	e-Line Flex Circu e 2003.	uits for 3D Multiple	e Die Packaging,"	Semiconductor
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Examine	Γ				Date Consider	rea

Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.